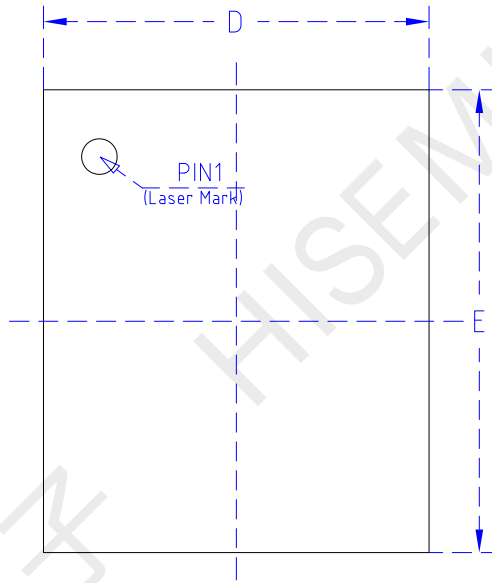
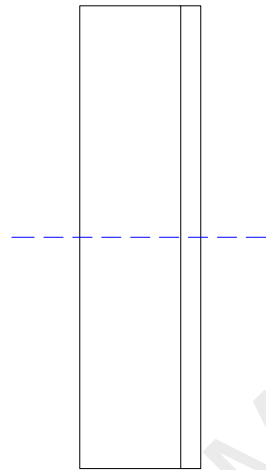


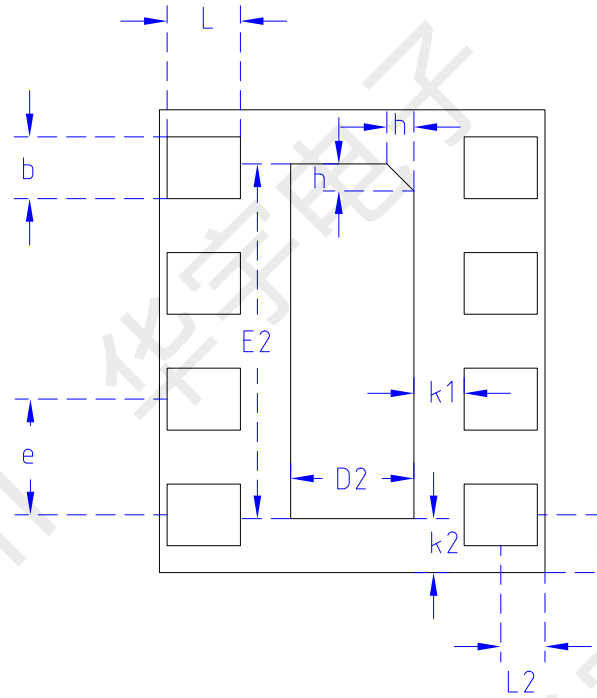
TOP VIEW
正视图



SIDE VIEW
侧视图

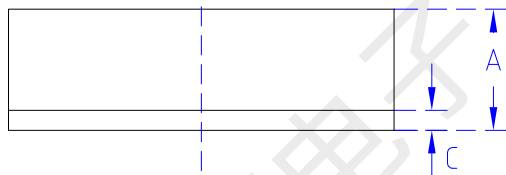



BOTTOM VIEW
背视图



机械尺寸/mm			
字符 SYMBOL	最小值 MIN	典型值 NOMINAL	最大值 MAX
A	1.21	1.31	1.41
c	0.22	0.26	0.30
b	0.75	0.80	0.85
D	4.90	5.00	5.10
D2	1.55	1.60	1.65
E	5.90	6.00	6.10
E2	4.55	4.60	4.65
e	1.50 BSC		
k1	0.60	0.65	0.70
k2	0.65	0.70	0.75
L	0.90	0.95	1.00
L1	0.65	0.70	0.75
L2	0.42	0.47	0.52
h	0.30	0.35	0.40

SIDE VIEW
侧视图



 池州华宇电子科技股份有限公司 CHI ZHOU HISEMI ELECTRONICS TECHNOLOGY CO.,LTD		制图: Draw	程玮 2022. 5. 16
图号 Drawing NO.	HY-POD-LGA8L (5×6×1.31-P1.50)		制图核查: Drawing review
Title 产品外形图	PACKAGE OUTLINE DIMENSIONS LGA8L (5×6×1.31-P1.50)		审核: Checker
幅图 size	页数 page	单位 unit	比例 scale
A4	1	mm	1:1
			视图 view
			核准: Approved